

SECTION B — PERFORMING OPERATIONS; TRANSPORTING

B81 MICRO-STRUCTURAL TECHNOLOGY

B81B MICRO-STRUCTURAL DEVICES OR SYSTEMS, e.g. MICRO-MECHANICAL DEVICES (piezo-electric, electrostrictive or magnetostrictive elements per se H01L 41/00) [7]

Note(s)

1. This subclass does not cover:
 - purely electrical or electronic devices per se which are covered by section H, e.g. subclass H01L;
 - purely optical devices per se which are covered by subclasses G02B or G02F;
 - essentially two-dimensional structures, e.g. layered products which are covered by subclass B32B;
 - chemical or biological structures per se which are covered by section C;
 - structures in atomic scale produced by manipulation of single atoms or molecules, which are covered by group B82B 1/00.
2. Devices or systems classified in this subclass are also classified in appropriate subclasses providing for their structural or functional features, if such features are of interest.

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| <p>1/00 Devices without movable or flexible elements, e.g. micro-capillary devices [7]</p> <p>3/00 Devices comprising flexible or deformable elements, e.g. comprising elastic tongues or membranes (B81B 5/00 takes precedence) [7]</p> <p>5/00 Devices comprising elements which are movable in relation to each other, e.g. comprising slidable or rotatable elements [7]</p> |
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| <p>7/00 Micro-structural systems [7]</p> <p>7/02 • containing distinct electrical or optical devices of particular relevance for their function, e.g. micro-electro-mechanical systems (MEMS) (B81B 7/04 takes precedence) [7]</p> <p>7/04 • Networks or arrays of similar micro-structural devices [7]</p> |
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